

C0805C301FBGACTU

Aliases (C0805C301FBGAC7800) SMD Comm COG HV, Ceramic, 300 pF, 1%, 630 VDC, COG, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 0805, 0.7 mm



Click here for the 3D model.

General Information		
Series	SMD Comm COG HV	
Style	SMD Chip	
Description	SMD, MLCC, Ultra-Stable, Low Loss, Class I	
Features	Ultra-Stable, Low Loss, Class I	
RoHS	Yes	
Termination	Tin	
Marking	No	
AEC-Q200	No	
Typical Component Weight	14 mg	
Shelf Life	78 Weeks	
MSL	1	

Specifications	
Capacitance	300 pF
Measurement Condition	1 MHz 1.0Vrms
Tolerance	1%
Voltage DC	630 VDC
Dielectric Withstanding Voltage	945 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
Dissipation Factor	0.1% 1 MHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms

 Dimensions

 Chip Size
 0805

 L
 2mm +/-0.2mm

 W
 1.25mm +/-0.2mm

 T
 1.25mm +/-0.15mm

 S
 0.7mm MIN

 B
 0.5mm +/-0.25mm

Packaging SpecificationsPackagingT&RPackaging Quantity2500

T&R, 180mm, Plastic Tape 2500

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